

# TK560P65Y

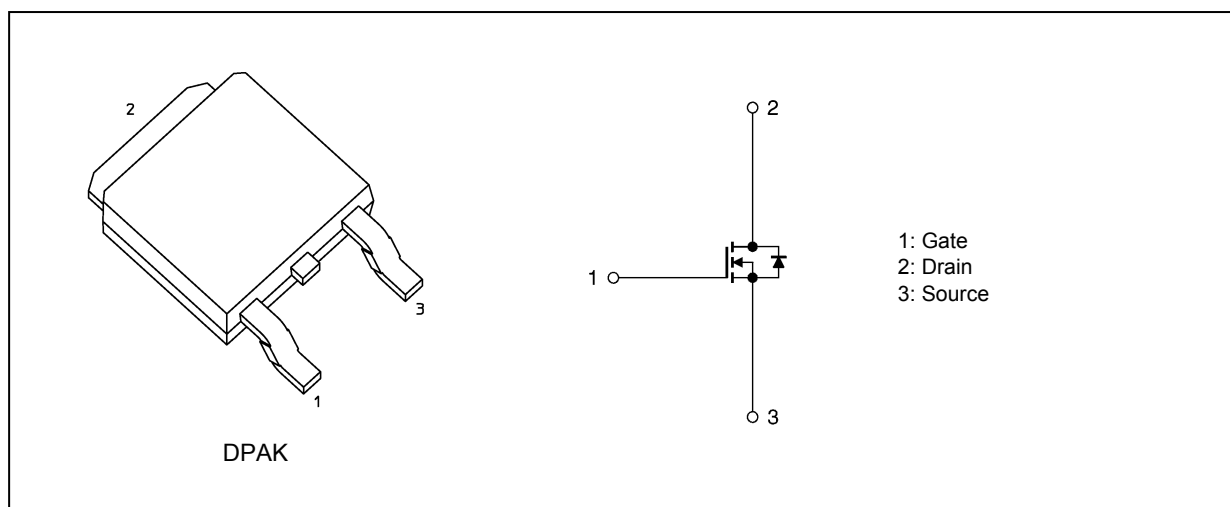
## 1. Applications

- Switching Voltage Regulators

## 2. Features

- (1) Low drain-source on-resistance:  $R_{DS(ON)} = 0.43 \Omega$  (typ.) by using Super Junction Structure : DTMOS
- (2) Easy to control Gate switching
- (3) Enhancement mode:  $V_{th} = 3$  to  $4$  V ( $V_{DS} = 10$  V,  $I_D = 0.24$  mA)

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25 \text{ }^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	650	V
Gate-source voltage	$V_{GSS}$	$\pm 30$	
Drain current (DC) ( $T_c = 25 \text{ }^\circ\text{C}$ ) (Note 1)	$I_D$	7	A
Drain current (DC) ( $T_c = 100 \text{ }^\circ\text{C}$ ) (Note 1)	$I_D$	4.4	A
Drain current (pulsed) ( $T_c = 25 \text{ }^\circ\text{C}$ ) (Note 1)	$I_{DP}$	28	A
Power dissipation ( $T_c = 25 \text{ }^\circ\text{C}$ )	$P_D$	60	W
Single-pulse avalanche energy (Note 2)	$E_{AS}$	59	mJ
Single-pulse avalanche current	$I_{AS}$	1.8	A
Reverse drain current (DC) (Note 1)	$I_{DR}$	7	A
Reverse drain current (pulsed) (Note 1)	$I_{DRP}$	28	A
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to 150	$^\circ\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production  
2016-12

**5. Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Channel-to-case thermal resistance	$R_{th(ch-c)}$	2.08	°C/W
Channel-to-ambient thermal resistance	$R_{th(ch-a)}$	125	

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2:  $V_{DD} = 90\text{ V}$ ,  $T_{ch} = 25\text{ °C}$  (initial),  $L = 32.5\text{ mH}$ ,  $R_G = 25\text{ }\Omega$ ,  $I_{AS} = 1.8\text{ A}$

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

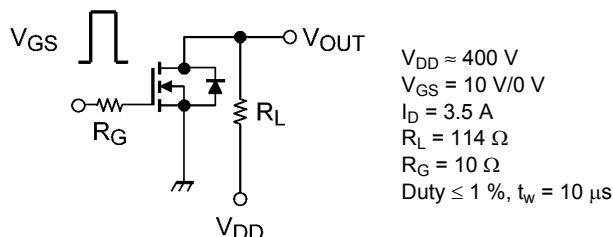
**6. Electrical Characteristics**

**6.1. Static Characteristics ( $T_a = 25\text{ }^\circ\text{C}$  unless otherwise specified)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 650\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	650	—	—	V
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 0.24\text{ mA}$	3	—	4	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 10\text{ V}, I_D = 3.5\text{ A}$	—	0.43	0.56	$\Omega$

**6.2. Dynamic Characteristics ( $T_a = 25\text{ }^\circ\text{C}$  unless otherwise specified)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 300\text{ V}, V_{GS} = 0\text{ V}, f = 100\text{ kHz}$	—	380	—	$\mu\text{F}$
Reverse transfer capacitance	$C_{rss}$		—	2.5	—	
Output capacitance	$C_{oss}$		—	18	—	
Effective output capacitance	$C_{o(er)}$	$V_{DS} = 0\text{ to }400\text{ V}, V_{GS} = 0\text{ V}$	—	30	—	
Gate resistance	$r_g$	$V_{DS} = \text{OPEN}, f = 1\text{ MHz}$	—	32	—	$\Omega$
Switching time (rise time)	$t_r$	See Figure 6.2.1	—	20	—	ns
Switching time (turn-on time)	$t_{on}$		—	50	—	
Switching time (fall time)	$t_f$		—	8	—	
Switching time (turn-off time)	$t_{off}$		—	105	—	
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} \leq V_{(BR)DSS}, I_D \leq 3.5\text{ A}$	50	—	—	V/ns



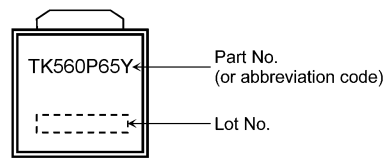
**Fig. 6.2.1 Switching Time Test Circuit**

**6.3. Gate Charge Characteristics ( $T_a = 25\text{ }^\circ\text{C}$  unless otherwise specified)**

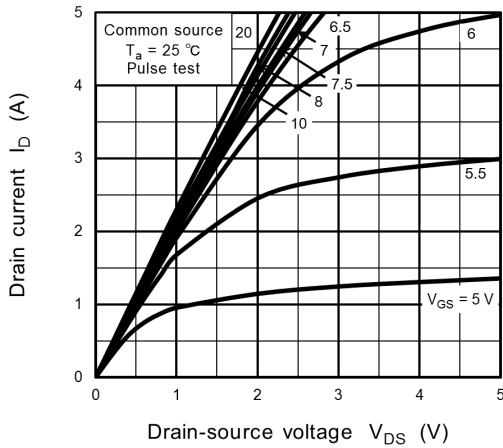
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 400\text{ V}, V_{GS} = 10\text{ V}, I_D = 7\text{ A}$	—	14.5	—	nC
Gate-source charge 1	$Q_{gs1}$		—	2.3	—	
Gate-drain charge	$Q_{gd}$		—	7.5	—	

**6.4. Source-Drain Characteristics ( $T_a = 25\text{ }^\circ\text{C}$  unless otherwise specified)**

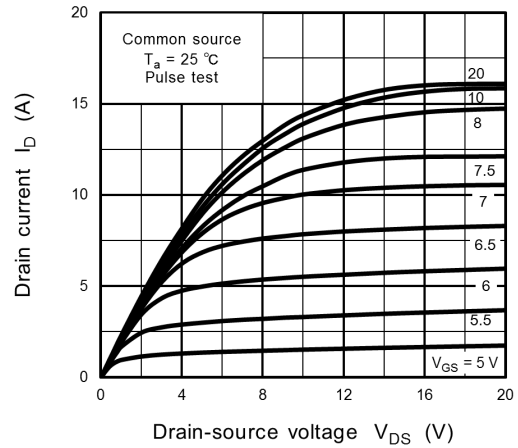
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Diode forward voltage	$V_{DSF}$	$I_{DR} = 7\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.7	V	
Reverse recovery time	$t_{rr}$	$V_{DD} \approx 400\text{ V}$ $I_{DR} = 3\text{ A}, V_{GS} = 0\text{ V}$ $-di_{DR}/dt = 100\text{ A}/\mu\text{s}$	—	240	—	ns	
Reverse recovery charge	$Q_{rr}$		—	1.6	—		$\mu\text{C}$
Peak reverse recovery current	$I_{rr}$		—	14.2	—		A
Diode dv/dt ruggedness	dv/dt	$V_{DS} \leq 400\text{ V}, I_{DR} \leq 3\text{ A}, V_{GS} = 0\text{ V}$	15	—	—	V/ns	

**7. Marking****Fig. 7.1 Marking**

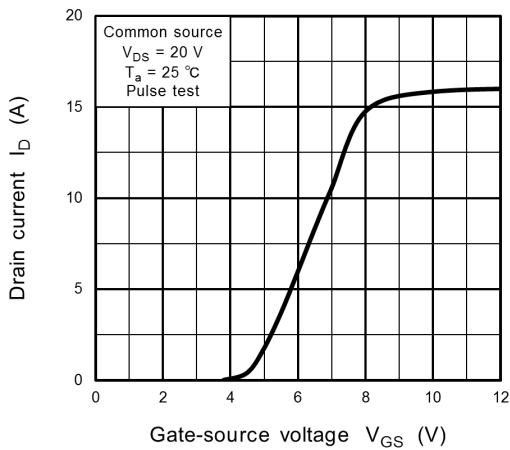
**8. Characteristics Curves (Note)**



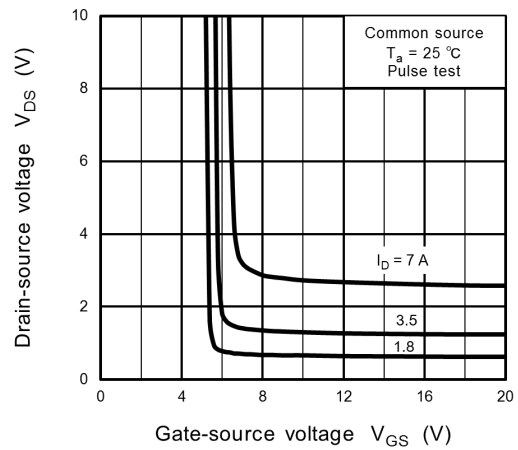
**Fig. 8.1  $I_D - V_{DS}$**



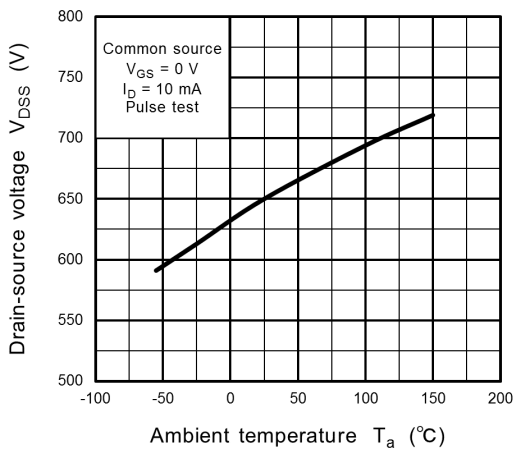
**Fig. 8.2  $I_D - V_{DS}$**



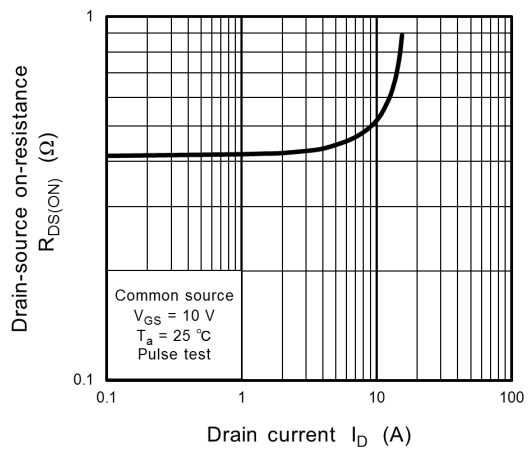
**Fig. 8.3  $I_D - V_{GS}$**



**Fig. 8.4  $V_{DS} - V_{GS}$**



**Fig. 8.5  $V_{DSS} - T_a$**



**Fig. 8.6  $R_{DS(ON)} - I_D$**

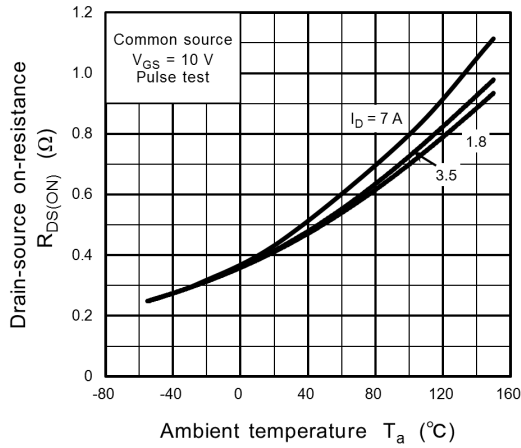


Fig. 8.7  $R_{DS(ON)} - T_a$

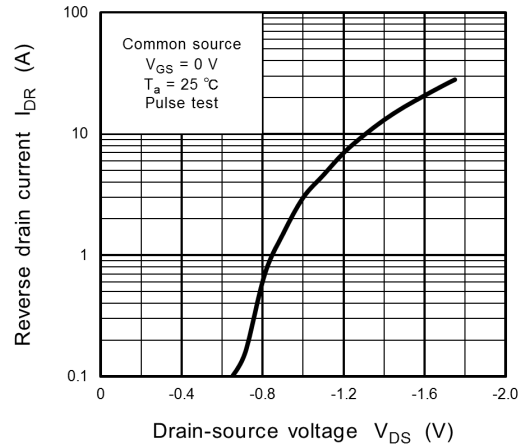


Fig. 8.8  $I_{DR} - V_{DS}$

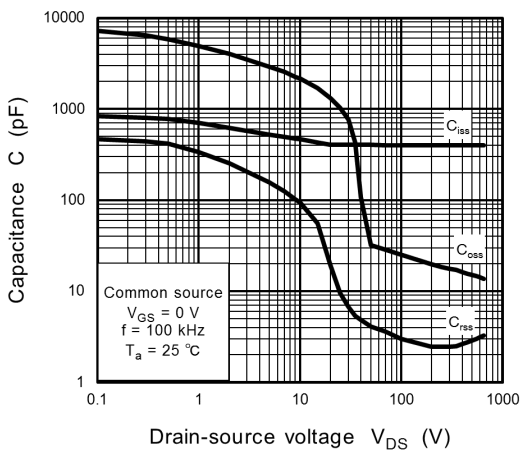


Fig. 8.9  $C - V_{DS}$

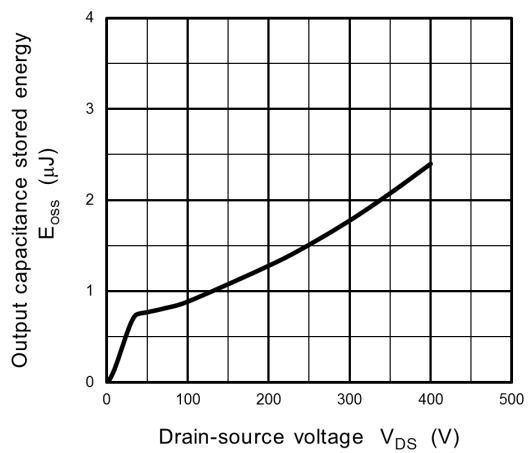


Fig. 8.10  $E_{OSS} - V_{DS}$

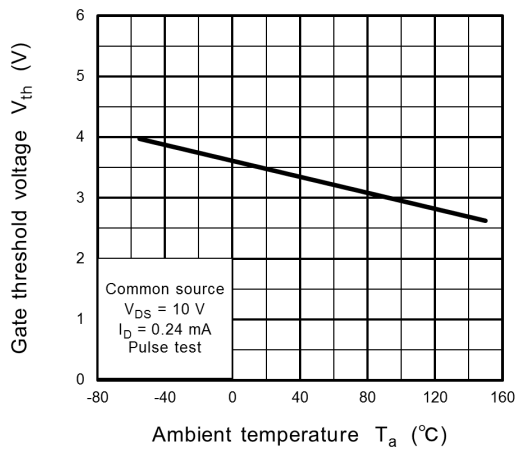


Fig. 8.11  $V_{th} - T_a$

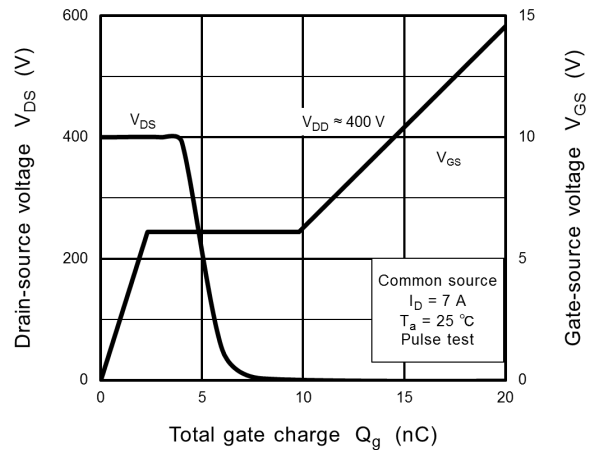
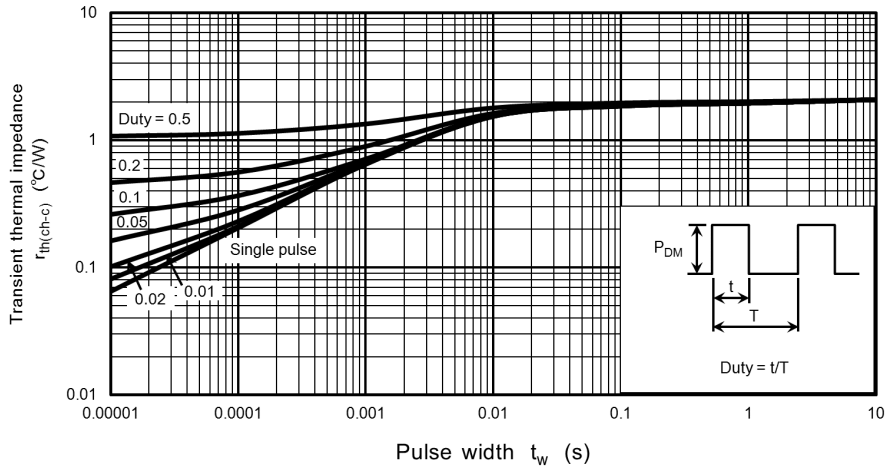
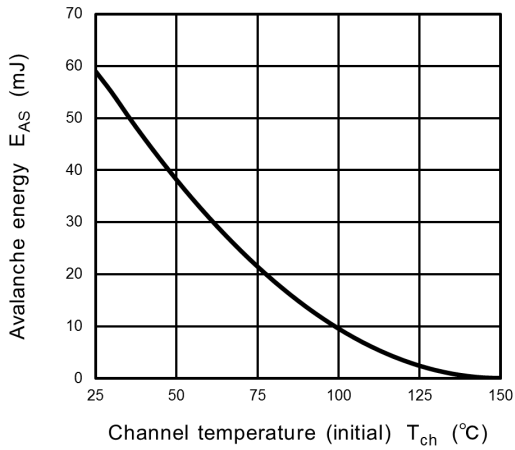


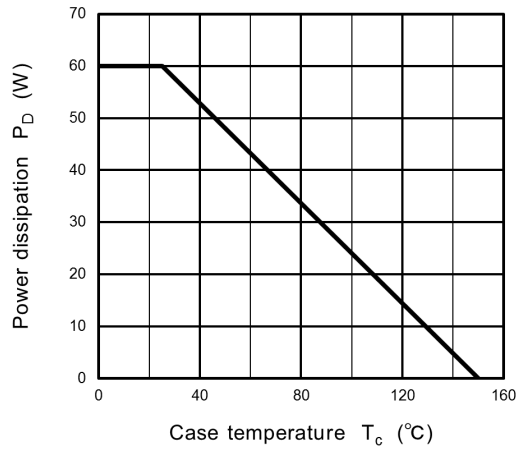
Fig. 8.12 Dynamic Input/Output Characteristics



**Fig. 8.13  $r_{th} - t_w$**   
(Guaranteed Maximum)



**Fig. 8.14  $E_{AS} - T_{ch}$**   
(Guaranteed Maximum)

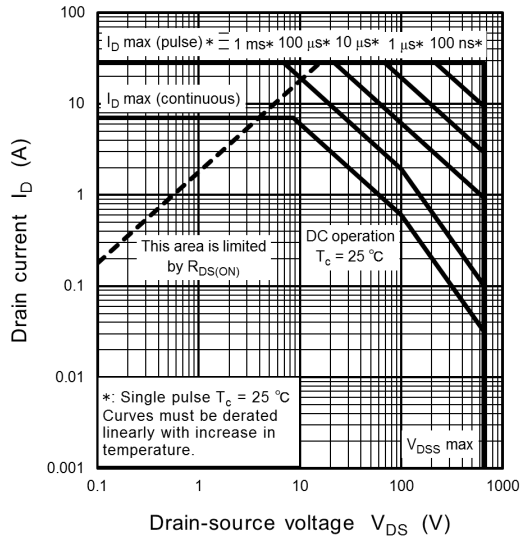


**Fig. 8.15  $P_D - T_c$**   
(Guaranteed Maximum)



$$R_G = 25 \Omega, V_{DD} = 90 \text{ V } E_{AS} = \frac{1}{2} \cdot L \cdot I_{AS}^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

**Fig. 8.16 Test Circuit/Waveform**



**Fig. 8.17 Safe Operating Area (Guaranteed Maximum)**

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

**Package Dimensions**

Unit: mm



Weight: 0.36 g (typ.)

Package Name(s)
TOSHIBA: 2-7K1S
Nickname: DPAK

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